



Dual N-Channel 40 V (D-S) MOSFET

PRODUCT SUMMARY						
V _{DS} (V)	$R_{DS(on)}(\Omega)$	I _D (A) ^a	Q _g (Typ.)			
40	0.0325 at V _{GS} = 10 V	7	3.3 nC			
40	0.040 at V _{GS} = 4.5 V	6.3	3.3110			

SO-8 D_1 G₁ D_1 D_2 D_2 G_2 Top View

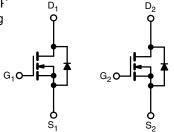
FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Gen III Power MOSFET
- 100 % R_q Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC

RoHS COMPLIANT **HALOGEN** FREE

APPLICATIONS

- DC/DC Converter
 - External HDD
 - Notebook System F
- LCD Display Backlig



N-Channel MOSFET N-Channel MOSFET

Ordering Information: Si4286DY-T1-GE3	(Lead (Pb)-free and Halogen-free)

Parameter	Symbol	Limit	Unit	
Drain-Source Voltage Gate-Source Voltage		V _{DS}	40 ± 20	V
		V _{GS}		v
	T _C = 25 °C		7	
Continuous Drain Current (T = 150 °C)	T _C = 70 °C		5.6	
Continuous Drain Current (T _J = 150 °C)	T _A = 25 °C	I _D	5.7 ^{b, c}	
	T _A = 70 °C		4.6 ^{b, c}	
Pulsed Drain Current (t = 300 μs)		I _{DM}	20	A
Continuous Source-Drain Diode Current	T _C = 25 °C		2.4	
Continuous Source-Drain Diode Current	T _A = 25 °C	l _s	1.6 ^{b, c}	
Single Pulse Avalanche Current	L = 0.1 mH	I _{AS}	8	
Single Pulse Avalanche Energy		E _{AS}	3.2	mJ
	T _C = 25 °C		2.9	
Manipular Davida Disabation	T _C = 70 °C		1.86	W
Maximum Power Dissipation	T _A = 25 °C	P _D	1.9 ^{b, c}	VV
	T _A = 70 °C	1	1.23 ^{b, c}	
Operating Junction and Storage Temperature	T _J , T _{stg}	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS							
Parameter	Symbol	Typical	Maximum	Unit			
Maximum Junction-to-Ambient ^{b, d}	t ≤ 10 s	R _{thJA}	55	65	°C/W		
Maximum Junction-to-Foot (Drain)	Steady State	R _{thJF}	35	43	C/VV		

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. Maximum under steady state conditions is 120 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static	Зушьог	rest conditions	IVIII.	Typ.	IVIAX.	Ollic	
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0, I _D = 250 μA	40			V	
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	VGS = 0, 1D = 230 μA	40	51		mV/°C	
V _{GS(th)} Temperature Coefficient	+	$I_D = 250 \mu A$		- 5			
Gate-Source Threshold Voltage	$\Delta V_{GS(th)}/T_J$	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.0	- 3	2.5	V	
	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu\text{A}$ $V_{DS} = 0 \text{V}$, $V_{GS} = \pm 20 \text{V}$	1.0		± 100	-	
Gate-Source Leakage	I _{GSS}					nA - μA - A	
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}$			1		
On-State Drain Current ^a	1	$V_{DS} = 40 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$ $V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	10		10		
On-State Diam Current	I _{D(on)}		10	0.007	0.0005	A	
Drain-Source On-State Resistance ^a	R _{DS(on)}	$V_{GS} = 10 \text{ V, } I_D = 8 \text{ A}$		0.027	0.0325	Ω	
Forward Transpoordingtones		$V_{GS} = 4.5 \text{ V}, I_D = 5 \text{ A}$		0.033	0.040	C	
Forward Transconductance ^a	9 _{fs}	V _{DS} = 10 V, I _D = 8 A		27		S	
Dynamic ^b				075		l	
Input Capacitance	C _{iss}			375		pF	
Output Capacitance	C _{oss}	$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		67			
Reverse Transfer Capacitance	C _{rss}			29			
Total Gate Charge	Q_g	$V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_D = 8 \text{ A}$		6.8	10.5	nC	
Cata Causa Chausa	Ů	V 00 V V 45 V L 0 A		3.3	5		
Gate-Source Charge	Q _{gs}	$V_{DS} = 20 \text{ V}, V_{GS} = 4.5 \text{ V}, I_D = 8 \text{ A}$		1			
Gate-Drain Charge	Q _{gd}	£ 4 NALL-	0.0	1.1	7.4	0	
Gate Resistance	R _g	f = 1 MHz	0.8	3.7	7.4	Ω	
Turn-On Delay Time	t _{d(on)}			33	60		
Rise Time	t _r	V_{DD} = 20 V, R_L = 2.5 Ω $I_D \approx 8$ A, V_{GEN} = 4.5 V, R_q = 1 Ω		60	110		
Turn-Off Delay Time	t _{d(off)}	$ID = 0 A$, $V_{GEN} - 4.3 V$, $II_g - 1.52$		17	34		
Fall Time	t _f			22	40	ns	
Turn-On Delay Time	t _{d(on)}			9	18		
Rise Time	t _r	$V_{DD} = 20 \text{ V}, R_L = 2.5 \Omega$		11	22	_	
Turn-Off Delay Time	t _{d(off)}	$I_D \approx 8 \text{ A}, V_{GEN} = 10 \text{ V}, R_g = 1 \Omega$		10	20		
Fall Time	t _f			7	14		
Drain-Source Body Diode Characteristi				1	1	Τ	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			2.4	Α	
Pulse Diode Forward Current	I _{SM}				20		
Body Diode Voltage	V_{SD}	$I_S = 3 A, V_{GS} = 0$		0.8	1.2	V	
Body Diode Reverse Recovery Time	t _{rr}			13	26	ns	
Body Diode Reverse Recovery Charge	Q_{rr}	I _F = 5 A, dI/dt = 100 A/μs, T _{.I} = 25 °C		6	12	nC	
Reverse Recovery Fall Time	t _a			7		ns	
Reverse Recovery Rise Time	t _b			6		115	

Notes:

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

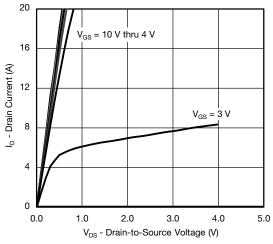
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

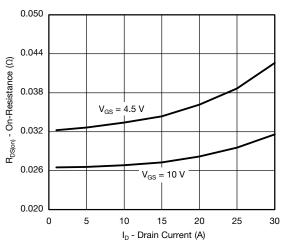




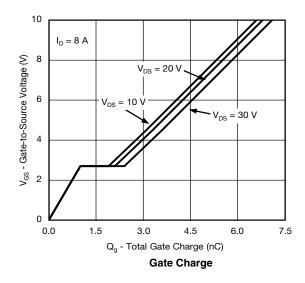
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

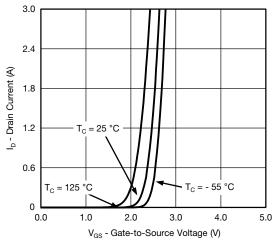


Output Characteristics

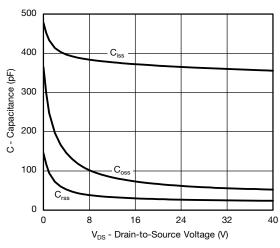


On-Resistance vs. Drain Current

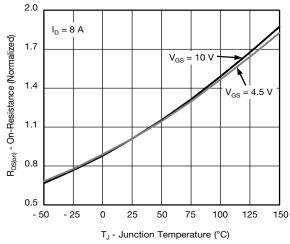




Transfer Characteristics



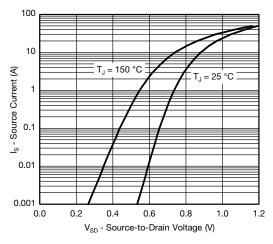
Capacitance



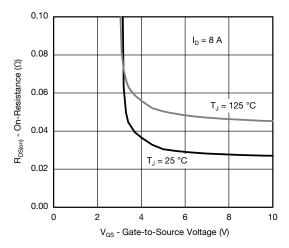
On-Resistance vs. Junction Temperature

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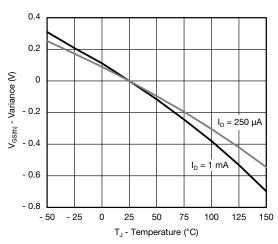
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



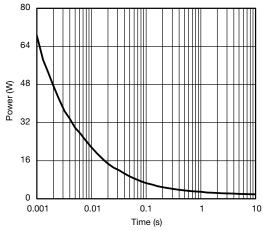
Source-Drain Diode Forward Voltage



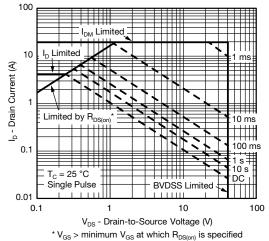
On-Resistance vs. Gate-to-Source Voltage







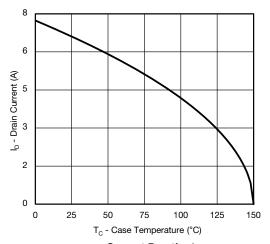
Single Pulse Power



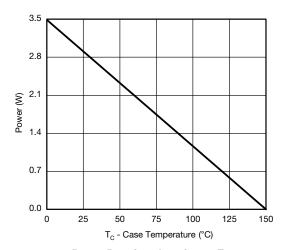
Safe Operating Area, Junction-to-Ambient

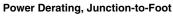


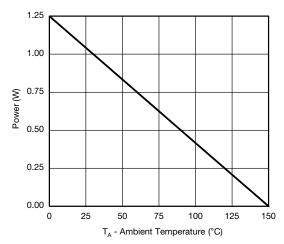
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Current Derating*





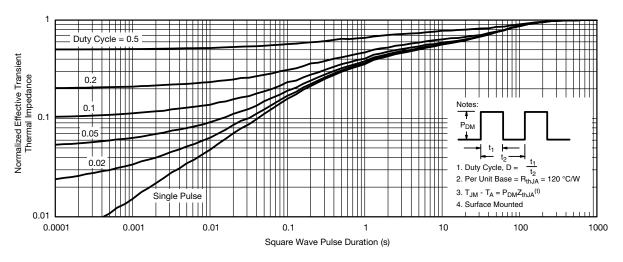


Power Derating, Junction-to-Ambient

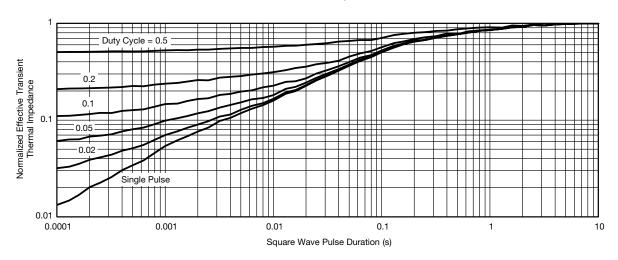
^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot

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SOIC (NARROW): 8-LEAD JEDEC Part Number: MS-012







	MILLIM	IETERS	INCHES		
DIM	Min	Max	Min	Max	
Α	1.35	1.75	0.053	0.069	
A ₁	0.10	0.20	0.004	0.008	
В	0.35	0.51	0.014	0.020	
С	0.19	0.25	0.0075	0.010	
D	4.80	5.00	0.189	0.196	
Е	3.80	4.00	0.150	0.157	
е	1.27	BSC	0.050 BSC		
Н	5.80	6.20	0.228	0.244	
h	0.25	0.50	0.010	0.020	
L	0.50	0.93	0.020	0.037	
q	0°	8°	0°	8°	
S	0.44	0.64	0.018	0.026	
ECN: C-06527-Rev. I. 11-Sep-06					

DWG: 5498

Document Number: 71192 www.vishay.com 11-Sep-06



RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads Dimensions in Inches/(mm)

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